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PATENTS ONI	N FORM COVER SHEET	Ž.	
TATENTS ON	42/09	HITA.0451	
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(1) Norikatsu TAKAURA, (2) Hideyuki			
MATSUOKA, (3) RIICHIRO TAKEMURA,		Name: Renesas Technology Corporation	
(4)KOUSUKE OKUYAMA, (5) MASAHIRO		Address: 4-1, Marunouchi 2-chome City: Chiyoda-ku, Tokyo	
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	IA AND (8) TOMONORI		
SEKIGUCHI Additional names of conveying parties attached: □ Yes ⋈ No			
3. Nature of Conveyance:			
	ity Agreement		
	Dates: (1)(2)(3)(8) November 4,		
2003; (4)(5) November 7, 2003; (6) November			
	d (7) November 19, 2003		
4. (a) Patent Application Number(s): 10/693,987		A (b) Protect Name on	
If this document is being filed together with a new application,		4. (b) Patent Numbers:	
	ate of the application is:	Miles vog = d mil	
5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:		6. Total Number of Applications and Patents Involved: 1	
Name:	Stanley P. Fisher	7. Total Fee: \$40.00 (37 C.F.R. § 3.41)	
Address:	Reed Smith LLP		
	3110 Fairview Park Dr.	☐ Enclosed. ☐ Authorized to be charged to deposit account.	
	Suite 1400 Falls Church, VA 22042	Authorized to be charged to deposit account.	
	,	8. Deposit Account Number: 08-1480	
		ATTACH DUPLICATE COPY OF THIS PAGE IF PAYING BY DEPOSIT ACCOUNT	
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9. Statement	and Signature:		
To the best	t of my knowledge and heliaf the foregoing is two	e and correct and any attached copy is a true copy of the	
original docum		A /	
	/11/14	February 2, 2004	
		rebruary 2, 2004	
Stanley P. Fishe	er, Registration No. 24, 344	Juan Carlos A. Marquez, Registration No. 34,072	
Total number of	f pages comprising cover sheet: 1		
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Patent and Trademark Office

PATENT REEL: 014942 FRAME: 0922

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp. a corporation organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp. its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

A SEMICONDUCTOR MEMORY DEVICE USING VERTICAL-CHANNNEL TRANSISTORS

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Technology Corp.

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.

Signed on the date(s) indicated aside our signatures:

RECORDED: 02/02/2004

INVENTOR(S)

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9)	
10)	

PATENT REEL: 014942 FRAME: 0923

Date Signed